

# 65HVD17xx Fault-Protected RS-485 Transceivers With Extended Common-Mode Range

#### **Features**

- · Bus-Pin Fault Protection to:
  - > ±70 V ('HVD1785, 86, 91, 92)
  - $> \pm 30 \text{ V ('HVD1787, 93)}$
- Common-Mode Voltage Range (–20 V to 25 V)
   More Than Doubles TIA/EIA 485 Requirement
- Bus I/O Protection
  - ±16 kV JEDEC HBM Protection
- Reduced Unit Load for Up to 256 Nodes
- Failsafe Receiver for Open-Circuit, Short-Circuit and Idle-Bus Conditions
- Low Power Consumption
  - Low Standby Supply Current, 1 μA Typical
  - I<sub>CC</sub> 5 mA Quiescent During Operation
- Power-Up, Power-Down Glitch-Free Operation

# **Applications**

Designed for RS-485 and RS-422 Networks

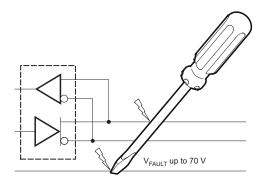
## **Description**

These devices are designed to survive overvoltage faults such as direct shorts to power supplies, miswiring faults, connector failures, cable crushes, and tool mis-applications. They are also robust to ESD events, with high levels of protection to human-body model specifications.

These devices combine a differential driver and a differential receiver, which operate from a single power supply. In the 'HVD1785, 'HVD1786, and 'HVD1787, the driver differential outputs and the receiver differential inputs are connected internally to form a bus port suitable for half-duplex (two-wire bus) communication. In the 'HVD1793, the driver differential outputs and the receiver differential inputs are separate pins, to form a bus port suitable for full-duplex (four-wire bus) communication. These ports feature a wide common-mode voltage range, making the devices suitable for multipoint applications over long cable runs. These devices are characterized from -40°C to 105°C.

For similar features with 3.3-V supply operation, see the 65HVD1781 (SLLS877).

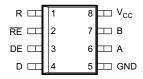
#### **Example of Bus Short to Power Supply**





# **Pin Configuration and Functions**

D or P Package 8-Pin SOIC or PDIP 65HVD1785, 1786, 1787 Top View



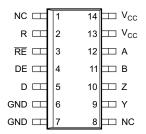
## Pin Functions (65HVD1785, 65HVD1786, 65HVD1787)

	PIN	TYPE	DESCRIPTION
NAME	NO.	ITPE	DESCRIPTION
A	6	Bus input/output	Driver output or receiver input (complementary to B)
В	7	Bus input/output	Driver output or receiver input (complementary to A)
D	4	Digital input	Driver data input
DE	3	Digital input	Driver enable, active high
GND	5	Reference potential	Local device ground
R	1	Digital output	Receive data output
RE	2	Digital input	Receiver enable, active low
V <sub>CC</sub>	8	Supply	4.5-V-to-5.5-V supply



# **Pin Configuration and Functions**

D Package 14-Pin SOIC 65VD1791, 1792, 1793 Top View



NC - No internal connection

Pins 6 and 7 are connected together internally.

Pins 13 and 14 are connected together internally.

#### Pin Functions (65HVD1791, 65HVD1792, 65HVD1793)

	PIN		
NAME	NO.	TYPE	DESCRIPTION
Α	12	Bus input	Receiver input (complementary to B)
В	11	Bus input	Receiver input (complementary to A)
Υ	9	Bus output	Driver output (complementary to Z)
Z	10	Bus output	Driver output (complementary to Y)
D	5	Digital input	Driver data input
DE	4	Digital input	Driver enable, active high
GND	6, 7	Reference potential	Local device ground
R	2	Digital output	Receive data output
RE	3	Digital input	Receiver enable, active low
V <sub>CC</sub>	13, 14	Supply	4.5-V to 5.5-V supply
NC	1, 8	No connect	No connect; should be left floating

# **Absolute Maximum Ratings**(1)

				MIN	MAX	UNIT
$V_{CC}$	Supply voltage			-0.5	7	٧
	'HVD1785, 86, 91, 92, 93		A, B pins	-70	70	V
	Voltage at bus pins	'HVD1787	A, B pins	-70	30	V
		'HVD1793	Y, Z pins	-70	30	V
	Input voltage at any logic pin	•		-0.3	$V_{CC} + 0.3$	٧
	Transient overvoltage pulse th	nrough 100 Ω per TIA-485		-100	100	V
	Receiver output current			-24	24	mA
TJ	Junction temperature				170	°C
T <sub>stg</sub>	Storage temperature				160	ů

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



## **ESD Ratings**

				VALUE	UNIT
	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> ,		Bus terminals and GND	±16000	
		JEDEC Standard 22, Test Method A114	All pins	±4000	
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22- JEDEC Standard 22, Test Method C101	C101 <sup>(2)</sup> ,	±2000	V
		Machine Model, JEDEC Standard 22, Test Method A115		±400	
		IEC 60749-26 ESD (human-body model)	Bus terminals and GND	±16000	

- JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### **Recommended Operating Conditions**

			MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	Supply voltage				V
VI	Input voltage at	any bus terminal (separately or common mode) <sup>(1)</sup>	-20		25	V
$V_{IH}$	High-level input	voltage (driver, driver enable, and receiver enable inputs)	2		$V_{CC}$	V
$V_{IL}$	Low-level input	voltage (driver, driver enable, and receiver enable inputs)	0		8.0	V
$V_{ID}$	Differential inpu	t voltage	-25		25	V
	Output current, driver		-60		60	mA
IO	Output current, receiver		-8		8	mA
$R_L$	Differential load	resistance	54	60		Ω
$C_L$	Differential load	capacitance		50		pF
		HVD1785, HVD1791			115	kbps
1/t <sub>UI</sub>	Signaling rate	HVD1786, HVD1792			1	N 41
		HVD1787, HVD1793			10	Mbps
T <sub>A</sub>	Operating free-air temperature (see application section for thermal information)		-40		105	°C
TJ	Junction temperature		-40		150	°C

<sup>(1)</sup> By convention, the least positive (most negative) limit is designated as minimum in this data sheet.

#### **Thermal Information**

THERMAL METRIC <sup>(1)</sup>		1	65HVD1786, D1787	65HVD1791, 65HVD1792, 65HVD1793	UNIT
		D (SOIC)	P (PDIP)	D (SOIC)	- 0
		8 PINS	8 PINS	14 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	138	59	95	°C/W
R <sub>0JA (low-K)</sub>	Junction-to-case (top) thermal resistance	242	128	168	°C/W
$R_{\theta JC(top)}$	Junction-to-board thermal resistance	61	61	44	°C/W
$R_{\theta JB}$	Junction-to-top characterization parameter	62	39	40	°C/W
ΨЈТ	Junction-to-board characterization parameter	3.4	17.6	8.2	°C/W
ΨЈВ	Junction-to-case (bottom) thermal resistance	33.4	28.3	25	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



## **Electrical Characteristics**

over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST COI	TEST CONDITIONS		TYP	MAX	UNIT
V <sub>OD</sub>	Driver differential output voltage magnitude	RS-485 with common-mode load, V <sub>CC</sub> > 4.75 V, see Figure 5	T <sub>A</sub> ≤ 85°C  T <sub>A</sub> ≤ 105°C	1.5			V
		R <sub>L</sub> = 54 Ω, 4.75 V ≤ V	<sub>CC</sub> ≤ 5.25 V	1.5	2		
		R <sub>L</sub> = 100 Ω, 4.75 V ≤ 3	V <sub>CC</sub> ≤ 5.25 V	2	2.5		
$\Delta  V_{OD} $	Change in magnitude of driver differential output voltage	R <sub>L</sub> = 54 Ω		-0.2	0	0.2	V
V <sub>OC(SS)</sub>	Steady-state common-mode output voltage			1	V <sub>CC</sub> /2	3	V
ΔV <sub>OC</sub>	Change in differential driver output common- mode voltage			-100	0	100	mV
V <sub>OC(PP)</sub>	Peak-to-peak driver common-mode output voltage	Center of two 27-Ω los see Figure 6	ad resistors,		500		mV
C <sub>OD</sub>	Differential output capacitance				23		pF
$V_{IT+}$	Positive-going receiver differential input voltage threshold				-100	-10	mV
V <sub>IT</sub>	Negative-going receiver differential input voltage threshold	$V_{CM} = -20 \text{ V to } 25 \text{ V}$		-200	-150		mV
V <sub>HYS</sub>	Receiver differential input voltage threshold hysteresis ( $V_{IT+} - V_{IT-}$ )			30	50		mV
V <sub>OH</sub>	Receiver high-level output voltage	I <sub>OH</sub> = -8 mA		2.4	V <sub>CC</sub> - 0.3		V
		I <sub>OH</sub> = -400 μA	1	4			
$V_{OL}$	Receiver low-level output voltage	I <sub>OL</sub> = 8 mA	T <sub>A</sub> ≤ 85°C		0.2	0.4	V
	· -		T <sub>A</sub> ≤ 105°C		0.2	0.5	
I <sub>I</sub>	Driver input, driver enable, and receiver enable input current			-100		100	μΑ
l <sub>OZ</sub>	Receiver output high-impedance current	$V_O = 0 \text{ V or } V_{CC}, \overline{RE}$ a	at V <sub>CC</sub>	-1		1	μΑ
los	Driver short-circuit output current			-250		250	mA
			85, 86, V <sub>I</sub> = 12 V		75	125	
I <sub>I</sub>	Bus input current (disabled driver)	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V or}$	91, 92 $V_1 = -7 V$	-100	-40		μA
"1	230par ourion (alloadiod diffor)	$V_{CC} = 0 \text{ V}, \text{ DE at } 0 \text{ V}$	87, 93 V <sub>I</sub> = 12 V			500	μ, ι
			$V_I = -7 \text{ V}$	-400			
		Driver and receiver enabled	$DE = V_{CC}$ , RE = GND, no load		4	6	
		Driver enabled, receiver disabled	$ \begin{aligned} DE &= V_{CC}, \\ RE &= V_{CC}, \\ no & load \end{aligned} $		3	5	mA
I <sub>CC</sub>	Supply current (quiescent)	Driver disabled, receiver enabled	DE = GND, RE = GND, no load		2	4	
		Driver and receiver disabled	DE = GND, D = open RE = V <sub>CC</sub> , no load		0.5	5	μΑ
	Supply current (dynamic)	See Typical Character	ristics				



## **Thermal Considerations**

PARAMETER		ΓER	TEST CONDITIONS	VALUE	UNIT
	85, 91		$V_{CC}$ = 5.5 V, $T_J$ = 150°C, $R_L$ = 300 $\Omega$ , $C_L$ = 50 pF (driver), $C_L$ = 15 pF (receiver) 5-V supply, unterminated <sup>(1)</sup>	290	
		85, 91			
_	86		$V_{CC}$ = 5.5 V, $T_J$ = 150°C, $R_L$ = 100 $\Omega$ , $C_L$ = 50 pF (driver), $C_L$ = 15 pF (receiver) 5-V supply, RS-422 load <sup>(1)</sup>	320	144
P <sub>D</sub>	Power dissipation	87	SE 10 pr (10001101) 0 1 0appry, 110 122 10aa		mW
		85, 91	$V_{CC} = 5.5 \text{ V}, T_{J} = 150 ^{\circ}\text{C}, R_{L} = 54 \Omega, C_{L} = 50 \text{ pF (driver)},$ $C_{I} = 15 \text{ pF (receiver)} 5-\text{V supply, RS-485 load}^{(1)}$		
		86		400	
	87		од тор (тоото) от обрруутто тоо това		
T <sub>SD</sub>	Thermal-shutdown jutemperature	unction		170	°C

<sup>(1)</sup> Driver and receiver enabled, 50% duty cycle square-wave signal at signaling rate: HVD1785, 1791 at 115 kbps, HVD1786 at 1 Mbps, HVD1787 at 10 Mbps)

## **Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
DRIVER (H	/D1785 AND HVD1791)						
t <sub>r</sub> , t <sub>f</sub>	Driver differential output rise/fall time					2.6	μs
t <sub>PHL</sub> , t <sub>PLH</sub>	Driver propagation delay	$R_L = 54 \Omega, C_L = 50 \mu$	oF,		0.8	2	μs
t <sub>SK(P)</sub>	Driver differential output pulse skew,  t <sub>PHL</sub> - t <sub>PLH</sub>	see Figure 7			20	250	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Driver disable time				0.1	5	μs
	Déces estable des	Receiver enabled	See Figure 8 and Figure 9		0.2	3	
t <sub>PZH</sub> , t <sub>PZL</sub>	Driver enable time	Receiver disabled	Tiguic 3		3	12	μs
DRIVER (H	/D1786 AND HVD1792)	<u>'</u>				·	
t <sub>r</sub> , t <sub>f</sub>	Driver differential output rise/fall time			50		300	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Driver propagation delay		$R_L = 54 \Omega, C_L = 50 pF,$			200	ns
t <sub>SK(P)</sub>	Driver differential output pulse skew,  tpHL - tpLH	see Figure 7				25	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Driver disable time					3	μs
		Receiver enabled	See Figure 8 and Figure 9			300	ns
t <sub>PZH</sub> , t <sub>PZL</sub>	Driver enable time	Receiver disabled	rigule 9			10	μs
		Receiver enabled	$V_{CM} > V_{CC}$		500		ns
DRIVER (H	/D1787 AND HVD1793)	<u>'</u>				'	
t <sub>r</sub> , t <sub>f</sub>	Driver differential output rise/fall time			3		30	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Driver propagation delay	$R_L = 54 \Omega, C_L = 50 \mu$	oF,			50	ns
t <sub>SK(P)</sub>	Driver differential output pulse skew,  tpHL - tpLH	see Figure 7	see Figure 7			10	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Driver disable time					3	μs
		Receiver enabled	See Figure 8 and Figure 9			300	ns
t <sub>PZH</sub> , t <sub>PZL</sub>	Driver enable time	Receiver disabled	I igule 3			9	μs
·		Receiver enabled	V <sub>CM</sub> > V <sub>CC</sub>		500		ns



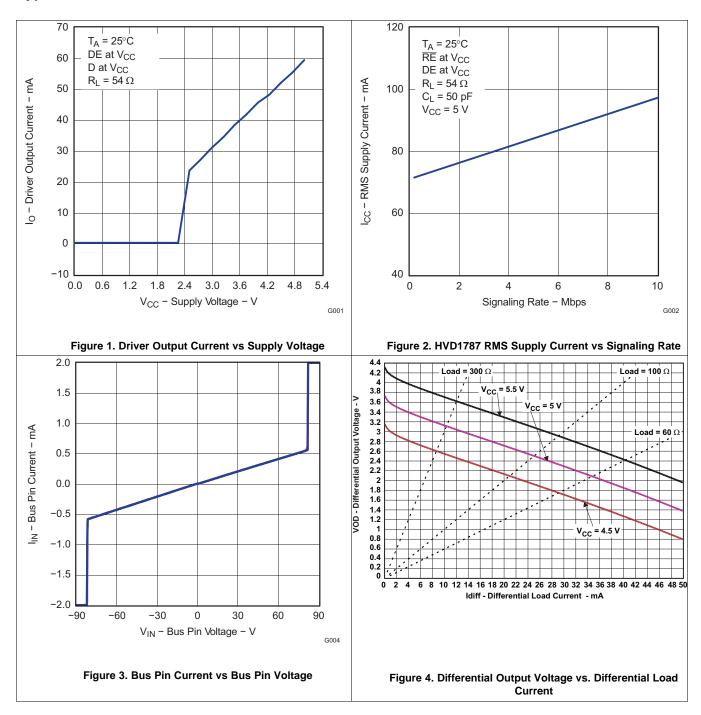
# **Switching Characteristics (continued)**

over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST C	TEST CONDITIONS			MAX	UNIT	
RECEIVER (A	ECEIVER (ALL DEVICES UNLESS OTHERWISE NOTED)							
t <sub>r</sub> , t <sub>f</sub>	Receiver output rise/fall time				4	15	ns	
			85, 86, 91, 92		100	200		
t <sub>PHL</sub> , t <sub>PLH</sub>	Receiver propagation delay time	$C_L = 15 \text{ pF},$ see Figure 10	87, 93			70	ns	
	Receiver output pulse skew,	occ rigure ro	85, 86, 91, 92		6	20		
t <sub>SK(P)</sub>	t <sub>PHL</sub> - t <sub>PLH</sub>		87, 93			5	ns	
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Receiver disable time	Driver enabled, se	e Figure 11		15	100	ns	
t <sub>PZL(1)</sub> , t <sub>PZH(1)</sub> t <sub>PZL(2</sub> ), t <sub>PZH(2)</sub>	Receiver enable time	Driver enabled, se	Driver enabled, see Figure 11		80	300	ns	
$t_{PZL(2)}, t_{PZH(2)}$	Receiver enable time	Driver disabled, se	Driver disabled, see Figure 12		3	9	μs	



## **Typical Characteristics**





#### **Parameter Measurement Information**

Input generator rate is 100 kbps, 50% duty cycle, rise and fall times less than 6 nsec, output impedance 50  $\Omega$ .

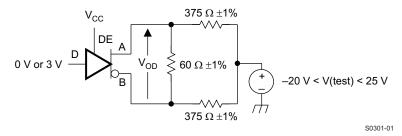


Figure 5. Measurement of Driver Differential Output Voltage With Common-Mode Load

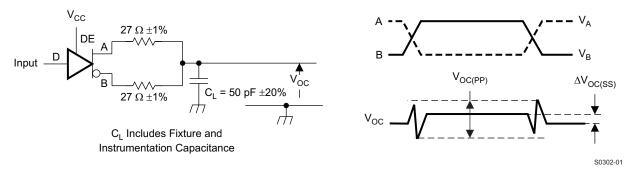


Figure 6. Measurement of Driver Differential and Common-Mode Output With RS-485 Load

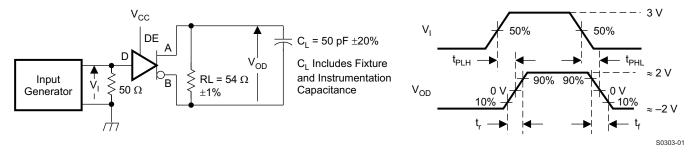
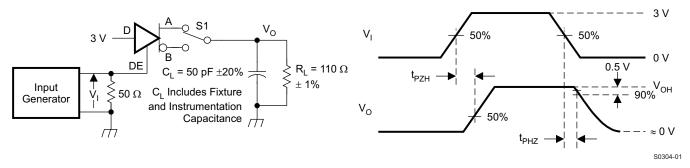


Figure 7. Measurement of Driver Differential Output Rise and Fall Times and Propagation Delays

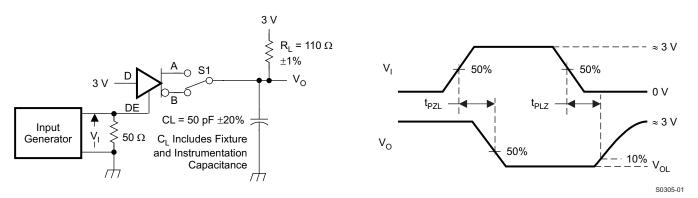


NOTE: D at 3 V to test non-inverting output, D at 0 V to test inverting output.

Figure 8. Measurement of Driver Enable and Disable Times With Active High Output and Pulldown Load



## **Parameter Measurement Information (continued)**



NOTE: D at 0 V to test non-inverting output, D at 3 V to test inverting output.

Figure 9. Measurement of Driver Enable and Disable Times With Active-Low Output and Pullup Load

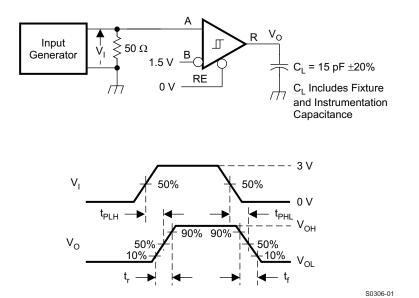


Figure 10. Measurement of Receiver Output Rise and Fall Times and Propagation Delays



# **Parameter Measurement Information (continued)**

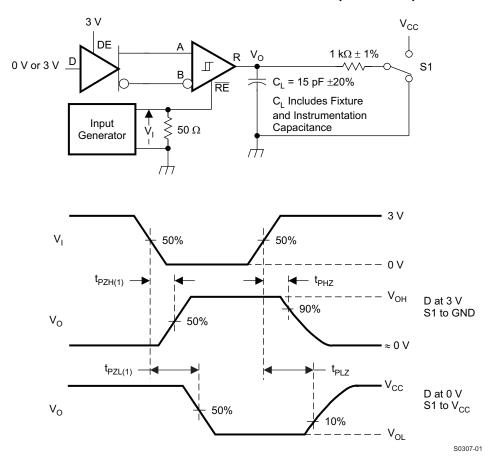


Figure 11. Measurement of Receiver Enable/Disable Times With Driver Enabled



# **Parameter Measurement Information (continued)**

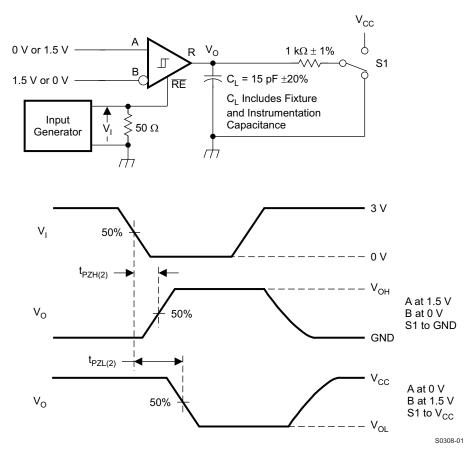


Figure 12. Measurement of Receiver Enable Times With Driver Disabled



## **Detailed Description**

#### Overview

The 65HVD17xx family of RS-485 transceivers are designed to operate up to 115 kbps (HVD1785 and HVD1791), 1 Mbps (HVD1786 and HVD1792), or 10 Mbps (HVD1787 or HVD1793) and to withstand DC overvoltage faults on the bus interface pins. This helps to protect the devices against damages resulting from direct shorts to power supplies, cable mis-wirings, connector failures, or other common faults.

The 65HVD178x devices are half-duplex, and thus have the transmitter and receiver bus interfaces connected together internally. The 65HVD179x family leaves these two interfaces separate, allowing for full-duplex communication. The low receiver loading allows for up to 256 nodes to share a common RS-485 bus. The devices feature a wide common-mode range as well as fail-safe receivers, which ensure a stable logic-level output during bus open, short, or idle conditions.

#### **Functional Block Diagram**

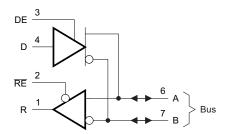


Figure 13. Half-Duplex Transceiver

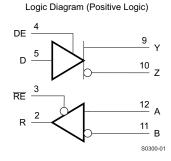


Figure 14. Full Duplex Transceiver

#### **Feature Description**

#### **Hot-Plugging**

These devices are designed to operate in hot swap or hot pluggable applications. Key features for hot-pluggable applications are power-up, power-down glitch free operation, default disabled input/output pins, and receiver failsafe. As shown in Figure 1, an internal Power-On Reset circuit keeps the driver outputs in a high-impedance state until the supply voltage has reached a level at which the device will reliably operate. This ensures that no spurious transitions (glitches) will occur on the bus pin outputs as the power supply turns on or turns off.

As shown in *Device Functional Modes*, the *ENABLE* inputs have the feature of default disable on both the driver enable and receiver enable. This ensures that the device will neither drive the bus nor report data on the R pin until the associated controller actively drives the enable pins.



### **Feature Description (continued)**

#### Receiver Failsafe

The differential receiver is failsafe to invalid bus states caused by:

- open bus conditions such as a disconnected connector,
- shorted bus conditions such as cable damage shorting the twisted-pair together,
- or idle bus conditions that occur when no driver on the bus is actively driving.

In any of these cases, the differential receiver outputs a failsafe logic High state, so that the output of the receiver is not indeterminate.

In the HVD17xx family of RS-485 devices, receiver failsafe is accomplished by offsetting the receiver thresholds so that the "input indeterminate" range does not include zero volts differential. In order to comply with the RS-422 and RS-485 standards, the receiver output must output a High when the differential input  $V_{ID}$  is more positive than 200 mV, and must output a Low when the  $V_{ID}$  is more negative than -200 mV. The HVD17xx receiver parameters which determine the failsafe performance are  $V_{IT+}$  and  $V_{IT-}$  and  $V_{HYS}$ . In the *Electrical Characteristics* table,  $V_{IT-}$  has a typical value of -150 mV and a minimum (most negative) value of -200 mV, so differential signals more negative than -200 mV will always cause a Low receiver output. Similarly, differential signals more positive than 200 mV will always cause a High receiver output, because the typical value of  $V_{IT+}$  is -100mV, and  $V_{IT+}$  is never more positive than -10 mV under any conditions of temperature, supply voltage, or common-mode offset.

When the differential input signal is close to zero, it will still be above the  $V_{IT+}$  threshold, and the receiver output will be High. Only when the differential input is more negative than  $V_{IT-}$  will the receiver output transition to a Low state. So, the noise immunity of the receiver inputs during a bus fault condition includes the receiver hysteresis value  $V_{HYS}$  (the separation between  $V_{IT+}$  and  $V_{IT-}$ ) as well as the value of  $V_{IT+}$ .

For the HVD17xx devices, the typical noise immunity is typically about 150 mV, which is the negative noise level needed to exceed the  $V_{IT-}$  threshold ( $V_{IT-}$  TYP = -150 mV). In the worst case, the failsafe noise immunity is never less than 40 mV, which is set by the maximum positive threshold ( $V_{IT+}$  MAX = -10 mV) plus the minimum hysteresis voltage ( $V_{HYS}$  MIN = 30 mV).

#### 70-V Fault-Protection

The 65HVD17xx family of RS-485 devices is designed to survive bus pin faults up to ±70V. The devices designed for fast signaling rate (10 Mbps) will not survive a bus pin fault with a direct short to voltages above 30V when:

- 1. the device is powered on AND
- 2a. the driver is enabled (DE=HIGH) AND D=HIGH AND the bus fault is applied to the A pin OR
- 2b. the driver is enabled (DE=HIGH) AND D=LOW AND the bus fault is applied to the B pin

Under other conditions, the device will survive shorts to bus pin faults up to 70V. Table 1 summarizes the conditions under which the device may be damaged, and the conditions under which the device will not be damaged.



## **Feature Description (continued)**

**Table 1. Device Conditions** 

POWER	DE	D	A	В	RESULTS
OFF	Χ	Χ	$-70V < V_A < 70V$	$-70V < V_B < 70V$	Device survives
ON	LO	Х	-70V < V <sub>A</sub> < 70V	$-70V < V_B < 70V$	Device survives
ON	H	L	-70V < V <sub>A</sub> < 70V	$-70V < V_B < 30V$	Device survives
ON	H	L	-70V < V <sub>A</sub> < 70V	$30V < V_B$	Damage may occur
ON	Ħ	Н	-70V < V <sub>A</sub> < 30V	$-70V < V_B < 30V$	Device survives
ON	Н	Н	30V < V <sub>A</sub>	$-70V < V_B < 30V$	Damage may occur

#### **Additional Options**

The 65HVD17xx family also has options for J1708 applications, for always-enabled full-duplex versions (industry-standard 65LBC179 footprint) and for inverting-polarity versions, which allow users to correct a reversal of the bus wires without re-wiring.

Table 2. 65HVD17xx Options for J1708 Applications

PART NUMBER	65HVD17xx				
FOOTPRINT/FUNCTION	SLOW	MEDIUM	FAST		
Half-duplex (176 pinout)	85	86	87		
Full-duplex no enables (179 pinout)	88	89	90		
Full-duplex with enables (180 pinout)	91	92	93		
Half-duplex with cable invert	94	95	96		
Full-duplex with cable invert and enables	97	98	99		
J1708	08	09	10		

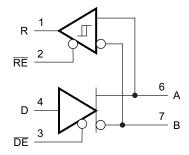


Figure 15. 65HVD1708E Transceiver for J1708 Applications

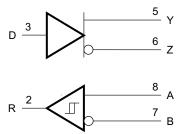
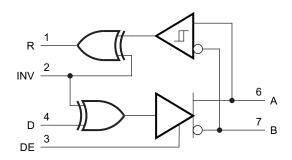


Figure 16. 65HVD17xx Always-Enabled Driver Receiver





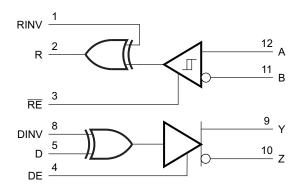


Figure 17. 65HVD17xx Options With Inverting Feature to Correct for Miswired Cables

## **Device Functional Modes**

**Table 3. Driver Function Table** 

INPUT	ENABLE	OUTPUTS		
D	DE	Α	В	
Н	Н	Н	L	Actively drive bus high
L	Н	L	Н	Actively drive bus low
X	L	Z	Z	Driver disabled
X	OPEN	Z	Z	Driver disabled by default
OPEN	Н	Н	L	Actively drive bus high by default

**Table 4. Receiver Function Table** 

DIFFERENTIAL INPUT	ENABLE	OUTPUT	
$V_{ID} = V_A - V_B$	RE	R	
$V_{IT+} < V_{ID}$	L	Н	Receive valid bus high
$V_{IT-} < V_{ID} < V_{IT+}$	L	?	Indeterminate bus state
$V_{ID} < V_{IT-}$	L	L	Receive valid bus low
X	Н	Z	Receiver disabled
X	OPEN	Z	Receiver disabled by default
Open-circuit bus	L	Н	Fail-safe high output
Short-circuit bus	L	Н	Fail-safe high output
Idle (terminated) bus	L	Н	Fail-safe high output



## **Application Information**

The 65HVD17xx family consists of both half-duplex and full-duplex transceivers that can be used for asynchronous data communication. Half-duplex implementations require one signaling pair (two wires), while full-duplex implementations require two signaling pairs (four wires). The driver and receiver enable pins of the 65HVD17xx family allow for control over the direction of data flow. Since it is common for multiple transceivers to share a common communications bus, care should be taken at the system level to ensure that only one driver is enabled at a time. This avoids bus contention, a fault condition in which multiple drivers attempt to send data at the same time.

### **Typical Application**

An RS-485 bus consists of multiple transceivers connecting in parallel to a bus cable. To eliminate line reflections, each cable end is terminated with a termination resistor,  $R_T$ , whose value matches the characteristic impedance,  $Z_0$ , of the cable. This method, known as parallel termination, allows for higher data rates over longer cable length.

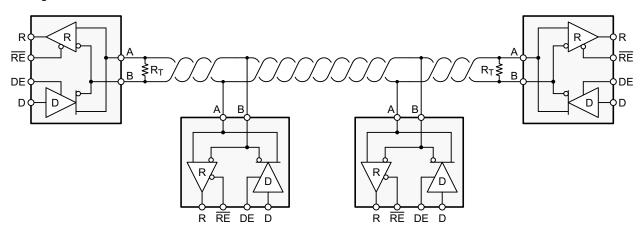


Figure 18. Typical RS-485 Network With Half-duplex Transceivers

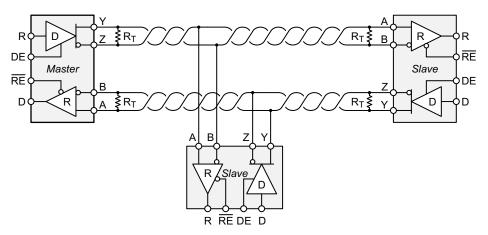


Figure 19. Typical RS-485 Network With Full-duplex Transceivers



## **Typical Application (continued)**

### **Design Requirements**

RS-485 is a robust electrical standard suitable for long-distance networking that may be used in a wide range of applications with varying requirements, such as distance, data rate, and number of nodes.

#### Data Rate and Bus Length

There is an inverse relationship between data rate and cable length, which means the higher the data rate, the short the cable length; and conversely, the lower the data rate, the longer the cable length. While most RS-485 systems use data rates between 10 kbps and 100 kbps, some applications require data rates up to 250 kbps at distances of 4000 feet and longer. Longer distances are possible by allowing for small signal jitter of up to 5 or 10%.

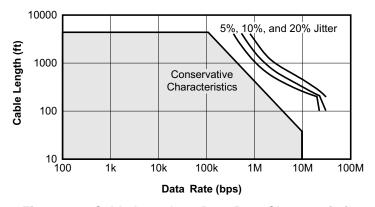


Figure 20. Cable Length vs Data Rate Characteristic

Even higher data rates are achievable (for example, 10 Mbps for the 65HVD1787 and 65HVD1793) in cases where the interconnect is short enough (or has suitably low attenuation at signal frequencies) to not degrade the data.

#### Stub Length

When connecting a node to the bus, the distance between the transceiver inputs and the cable trunk, known as the stub, should be as short as possible. Stubs present a non-terminated piece of bus line which can introduce reflections as the length of the stub increases. As a general guideline, the electrical length, or round-trip delay, of a stub should be less than one-tenth of the rise time of the driver, thus giving a maximum physical stub length as shown in Equation 1.

$$L_{stub} \le 0.1 \times t_r \times v \times c$$

#### where

- t<sub>r</sub> is the 10/90 rise time of the driver
- c is the speed of light (3 x 10<sup>8</sup> m/s)
- v is the signal velocity of the cable or trace as a factor of c

#### Receiver Failsafe

The differential receiver of the 65HVD17xx family is failsafe to invalid bus states caused by:

- · Open bus conditions, such as a disconnected connector
- Shorted bus conditions, such as cable damage shorting the twisted-pair together
- Idle bus conditions that occur when no driver on the bus is actively driving
- n any of these cases, the differential receiver will output a failsafe logic high state so that the output of the receiver is not indeterminate.

(1)



### **Typical Application (continued)**

Receiver failsafe is accomplished by offsetting the receiver thresholds such that the "input indeterminate" range does not include zero volts differential. In order to comply with the RS-422 and RS-485 standards, the receiver output must output a high when the differential input  $V_{ID}$  is more positive than +200 mV, and must output a low when VID is more negative than -200 mV. The receiver parameters which determine the failsafe performance are  $V_{IT(+)}$  and  $V_{IT(-)}$ . As shown in the Electrical Characteristics table, differential signals more negative than -200 mV will always cause a low receiver output, and differential signals more positive than +200 mV will always cause a high receiver output.

When the differential input signal is close to zero, it is still above the maximum  $V_{IT(+)}$  threshold of -10 mV, and the receiver output will be high.

## **Detailed Design Procedure**

Although the 65HVD17xx family is internally protected against human-body-model ESD strikes up to 16 kV, additional protection against higher-energy transients can be provided at the application level by implementing external protection devices.

## **Application Curve**

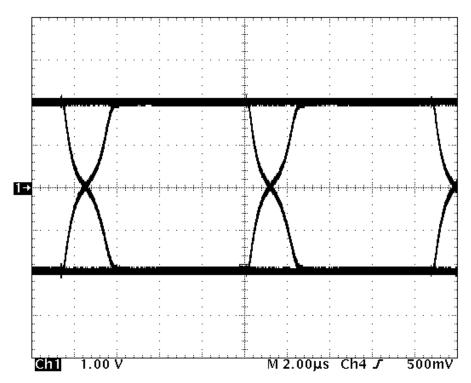


Figure 21. 65HVD1785 Differential Output at 115 kbps



# Important statement:

Huaguan Semiconductor Co,Ltd. reserves the right to change the products and services provided without notice. Customers should obtain the latest relevant information before ordering, and verify the timeliness and accuracy of this information.

Customers are responsible for complying with safety standards and taking safety measures when using our products for system design and machine manufacturing to avoid potential risks that may result in personal injury or property damage.

Our products are not licensed for applications in life support, military, aerospace, etc., so we do not bear the consequences of the application of these products in these fields.

Our documentation is only permitted to be copied without any tampering with the content, so we do not accept any responsibility or liability for the altered documents.

20

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RS-422/RS-485 Interface IC category:

Click to view products by HGSEMI manufacturer:

Other Similar products are found below:

SP3494CN-L/TR CA-IS3082WX CA-IS3088WX CA-IS3092W XR33038IDTR-F SIT3485ISO XR3077XID-F ADM2687EBRIZ-RL7

SP483EEN-L/TR SN75LBC175ADR SN65ALS1176DR MAX489CPD+ MAX3080CPD+ MXL1535EEWI+ SP483EN-L/TR SP483CNL/TR XR3072XID-F DS16F95J/883 SP1485EEN-L/TR MAX490ESA+T ISL3179EIUZ-T7A ISL3179EIRZ-T7A ISL3179EFRZ-T7A

XR33193ESBTR XR33194ESBTR XR3074XID-F XR3082XID-F SP3490EN-L ADM485JN ADM1485JNZ ADM2687EBRIZ

ADM3491ARZ-REEL7 ADM489ABRZ ADM3073EARZ ADM4850ACPZ-REEL7 ADM4853ACPZ-REEL7 ADM485ANZ

ADM3072EARZ-REEL7 ADM3075EARZ-REEL7 ADM3486EARZ-REEL7 ADM3493ARZ-REEL7 ADM4856ARZ-REEL7

ADM487EARZ-REEL7 ADM1485JRZ-REEL ADM3490ARZ-REEL7 ADM3490EARZ-REEL7 ADM1485ARZ-REEL ADM3071EARZ

ADM3483EARZ-REEL7 ADM3485EARZ-REEL7